

September 1998

File Number

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## Ultra High Slew RateOperational Amplifier

The HFA-0001 is an all bipolar op amp featuring high slew rate ( $1000V/\mu s$ ), and high unity gain bandwidth (350MHz). These features combined with fast settling time (25ns) make this product very useful in high speed data acquisition systems as well as RF, video, and pulse amplifier designs. Other outstanding characteristics include low bias currents ( $15\mu A$ ), low offset current ( $18\mu A$ ), and low offset voltage (6mV).

The HFA-0001 offers high performance at low cost. It can replace hybrids and RF transistor amplifiers, simplifying designs while providing increased reliability due to monolithic construction. To enhance the ease of design, the HFA-0001 has a  $50\Omega \pm 20\%$  resistor connected from the output of the op amp to a separate pin. This can be used when driving  $50\Omega$  strip line, microstrip, or coax cable.

### Part Number Information

PART NUMBER	TEMPERATURE RANGE	PACKAGE
HFA1-0001-5	0°C to +75°C	14 Lead Ceramic Sidebraze DIP
HFA1-0001-9	-40°C to +85°C	14 Lead Ceramic Sidebraze DIP
HFA3-0001-5	0°C to +75°C	8 Lead Plastic DIP
HFA3-0001-9	-40°C to +85°C	8 Lead Plastic DIP
HFA9P0001-5	0°C to +75°C	16 Lead Widebody SOIC

#### **Features**

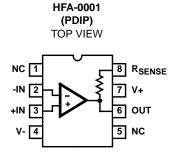
Unity Gain Bandwidth	350MHz
Full Power Bandwidth	. 53MHz
High Slew Rate	I000V/μs
High Output Drive	. ±50mA

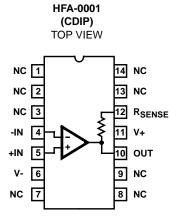
· Monolithic Construction

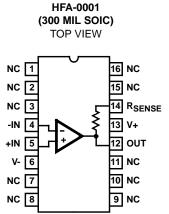
## **Applications**

- RF/IF Processors
- Video Amplifiers
- · High Speed Cable Drivers
- · Pulse Amplifiers
- · High Speed Communications
- · Fast Data Acquisition Systems

#### **Pinouts**







## **Absolute Maximum Ratings** (Note 1)

# **Operating Conditions**

Supply Voltage (Between V+ and V- Terminals)	
Differential Input Voltage	
Input Voltage	
Output Current	
Junction Temperature (Note 9) +175°C	
Junction Temperature (Plastic Package) +150°C	
Lead Temperature (Soldering 10 Sec.) +300°C	

Operating Temperature Range	
HFA-0001-9	40°C $\leq$ T <sub>A</sub> $\leq$ +85°C
HFA-0001-5	$0^{\circ}C \le T_{A} \le +75^{\circ}C$
Storage Temperature Range	65°C $\leq T_A \leq +150$ °C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

# **Electrical Specifications** V+ = +5V, V- = -5V, Unless Otherwise Specified

			HFA-0001-9		HFA-0001-5				
PARAMETER		TEMP	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
INPUT CHARACTERISTIC	S	<del>'</del>	'	•	!	!		!	!
Offset Voltage		+25 <sup>o</sup> C	-	6	15	-	6	30	mV
		High	-	4.5	20	-	4.5	30	mV
		Low	-	12.5	45	-	12.5	35	mV
Average Offset Voltage Dr	ift	High	-	50	-	-	50	-	μV/ <sup>o</sup> C
		Low	-	100	-	-	100	-	μV/ <sup>o</sup> C
Bias Current		+25°C	-	15	50	-	15	100	μΑ
		Full	-	20	50	-	20	100	μΑ
Offset Current		+25°C	-	18	25	-	18	50	μА
		Full	-	22	50	-	22	50	μА
Common Mode Range		+25°C	±3	-	-	±3	-	-	V
Differential Input Resistance	ce	+25°C	-	10	-	-	10	-	kΩ
Input Capacitance		+25°C	-	2	-	-	2	-	pF
Input Noise Voltage	0.1Hz to 10Hz	+25°C	-	3.5	-	-	3.5	-	μVrms
	10Hz to 1MHz	+25°C	-	6.7	-	-	6.7	-	μVrms
Input Noise Voltage	f <sub>O</sub> = 10Hz	+25°C	-	640	-	-	640	-	nV/√ <del>Hz</del>
	f <sub>O</sub> = 100Hz	+25°C	-	170	-	-	170	-	nV/√ <del>Hz</del>
	f <sub>O</sub> = 100kHz	+25 <sup>0</sup> C	-	6	-	-	6	-	nV/√ <del>Hz</del>
Input Noise Current	f <sub>O</sub> = 10Hz	+25°C	-	2.35	-	-	2.35	-	nA/√ <del>Hz</del>
	f <sub>O</sub> = 100Hz	+25°C	-	0.57	-	-	0.57	-	nA/√ <del>Hz</del>
	f <sub>O</sub> = 1000Hz	+25 <sup>0</sup> C	-	0.16	-	-	0.16	-	nA/√ <del>Hz</del>
TRANSFER CHARACTER	ISTICS	<b>"</b>	1			ı			1
Large Signal Voltage Gain	(Note 2)	+25 <sup>0</sup> C	150	200	-	150	200	-	V/V
		High	150	170	-	100	170	-	V/V
		Low	150	220	-	150	220	-	V/V
Common Mode Rejection I	Ratio (Note 3)	+25°C	45	47	-	42	47	-	dB
		High	40	45	-	40	45	-	dB
		Low	45	48	-	42	48	-	dB
Unity Gain Bandwidth		+25°C	-	350	-	-	350	-	MHz
Minimum Stable Gain		Full	1	-	-	1	-	-	V/V
OUTPUT CHARACTERIS	TICS	1	1	1	1	1	1	1	I
Output Voltage Swing	$R_L = 100\Omega$	+25°C	-	±3.5	-	-	±3.5	-	V

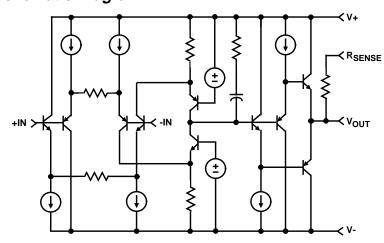
### Electrical Specifications V+ = +5V, V- = -5V, Unless Otherwise Specified (Continued)

			HFA-0001-9			HFA-0001-5			
PARAMETER		TEMP	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
	$R_L = 1k\Omega$	+25°C	±3.5	±3.7	-	±3.5	±3.7	-	V
		High	±3.0	±3.6	-	±3.0	±3.6	-	V
		Low	±3.5	±3.7	-	±3.5	±3.7	-	V
Full Power Bandwidth (Note	e 5)	+25°C	-	53	-	-	53	-	MHz
Output Resistance, Open L	oop	+25°C	-	3	-	-	3	-	Ω
Output Current		Full	±30	±50	-	±30	±50	-	mA
TRANSIENT RESPONSE		I				ı	ı		
Rise Time (Note 4, 6)		+25°C	-	480	-	-	480	-	ps
Slew Rate (Note 4, 7)	$R_L = 1k\Omega$	+25°C	-	1000	-	-	1000	-	V/µs
	$R_L = 100\Omega$	+25°C	-	875	-	-	875	-	V/µs
Settling Time (3V Step)	0.1%	+25°C	-	25	-	-	25	-	ns
Overshoot (Note 4, 6)		+25°C	-	36	-	-	36	-	%
POWER SUPPLY CHARAC	TERISTICS								
Supply Current		Full	-	65	75	-	65	75	mA
Power Supply Rejection Ratio (Note 8)		+25°C	40	42	-	37	42	-	dB
		High	35	41	-	35	41	-	dB
		Low	40	42	-	37	42	-	dB

#### NOTES:

- 1. Absolute Maximum Ratings are limiting values applied individually beyond which the serviceability of the circuit may be impaired. Functional operation under any of these conditions is not necessarily implied.
- 2.  $V_{OUT} = 0$  to  $\pm 2V$ ,  $R_L = 1k\Omega$ .
- 3.  $\Delta V_{CM} = \pm 2V$ .
- 4.  $R_L = 100\Omega$ . 5. Full Power Bandwidth is calculated by equation: FPBW =  $\frac{SlewRate}{2\pi V_{PEAK}}$ ,  $V_{PEAK} = 3.0 V$ .
- 6.  $V_{OUT} = \pm 200 \text{mV}, A_V = +1.$ 7.  $V_{OUT} = \pm 3 \text{V}, A_V = +1.$
- 8.  $\Delta V_S = \pm 4V$  to  $\pm 6V$ .
- 9. See Thermal Constants in 'Applications Information' text. Maximum power dissipation, including output load, must be designed to maintain the junction temperature below +175°C for hermetic packages, and below +150°C for plastic packages.

# Schematic Diagram



### Die Characteristics

Thermal Constants ( <sup>o</sup> C/W)	$\theta$ JA	$\theta$ JC
HFA1-0001-5/-9	75	13
HFA3-0001-5	98	36
HFA9P-0001-5/-9	96	27

### **Test Circuits**

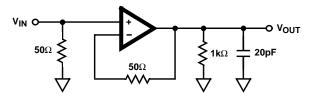


FIGURE 1. LARGE SIGNAL RESPONSE TEST CIRCUIT

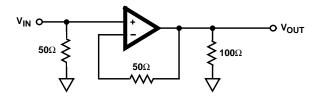
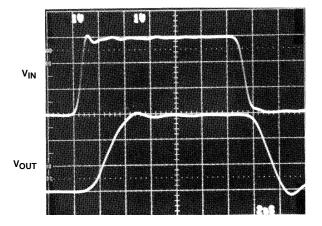


FIGURE 2. SMALL SIGNAL RESPONSE TEST CIRCUIT

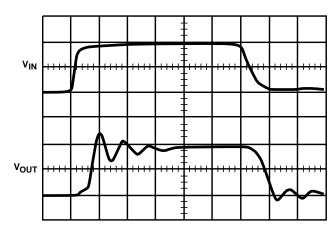
#### LARGE SIGNAL RESPONSE

V<sub>OUT</sub> = 0V to 3V Vertical Scale: 1V/Div. Horizontal Scale: 2ns/Div.



### **SMALL SIGNAL RESPONSE**

V<sub>OUT</sub> = 0mV to 200mV Vertical Scale: 100mV/Div. Horizontal Scale: 2ns/Div.



NOTE: Initial Step In Output Is Due To Fixture Feedthrough

### PROPAGATION DELAY

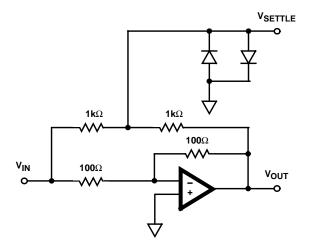
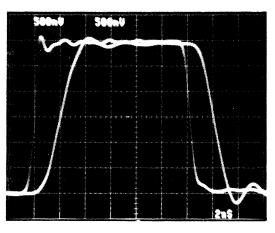
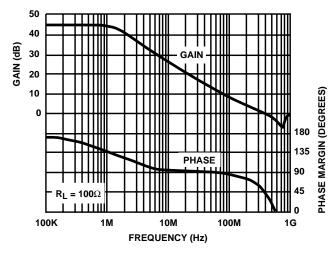


FIGURE 3. SETTLING TIME SCHEMATIC



NOTE: Test Fixture Delay of 450ps is Included

# **Typical Performance Curves** $V_S = \pm 5V$ , $T_A = +25^{\circ}C$ , Unless Otherwise Specified



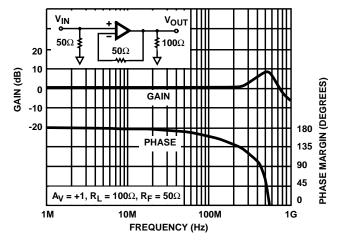
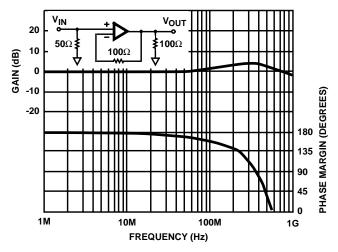


FIGURE 4. OPEN LOOP GAIN AND PHASE vs FREQUENCY

FIGURE 5. CLOSED LOOP GAIN vs FREQUENCY





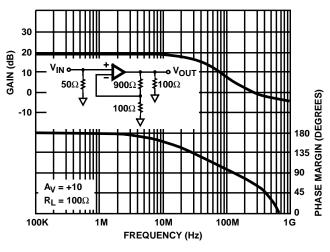


FIGURE 7. CLOSED LOOP GAIN vs FREQUENCY

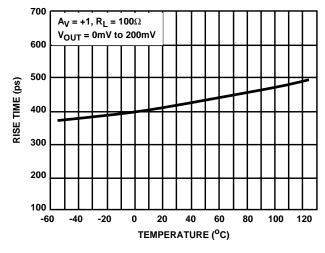


FIGURE 8. RISE TIME vs TEMPERATURE

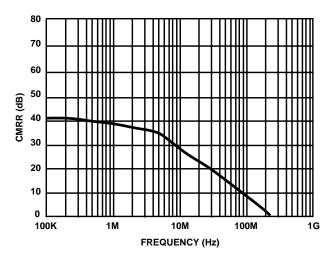


FIGURE 9. CMRR vs FREQUENCY

# **Typical Performance Curves** $V_S = \pm 5V$ , $T_A = +25^{\circ}C$ , Unless Otherwise Specified (Continued)

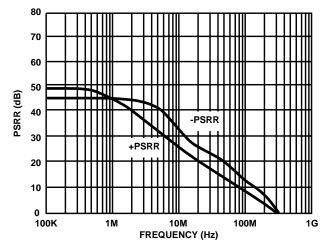


FIGURE 10. PSRR vs FREQUENCY

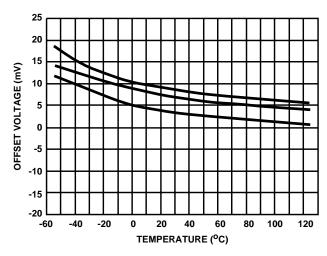


FIGURE 11. OFFSET VOLTAGE vs TEMPERATURE (3 REPRESENTATIVE UNITS)

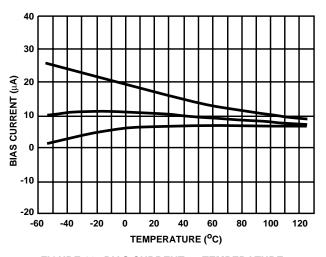


FIGURE 12. BIAS CURRENT VS TEMPERATURE (3 REPRESENTATIVE UNITS)

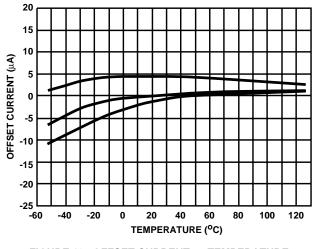


FIGURE 13. OFFSET CURRENT vs TEMPERATURE (3 REPRESENTATIVE UNITS)

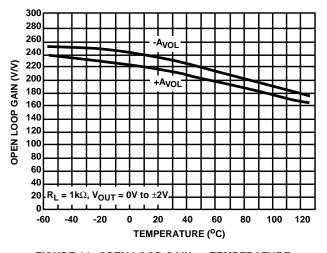


FIGURE 14. OPEN LOOP GAIN vs TEMPERATURE

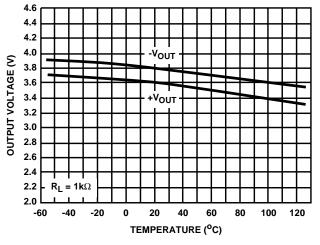


FIGURE 15. OUTPUT VOLTAGE SWING vs TEMPERATURE

# **Typical Performance Curves** $V_S = \pm 5V$ , $T_A = +25^{\circ}C$ , Unless Otherwise Specified (Continued)

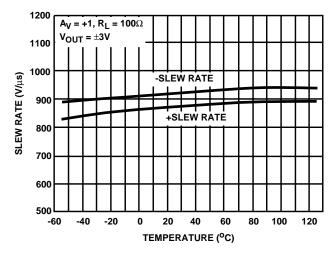


FIGURE 16. SLEW RATE vs TEMPERATURE

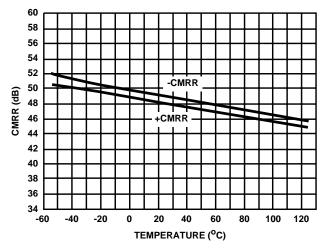


FIGURE 17. CMRR vs TEMPERATURE

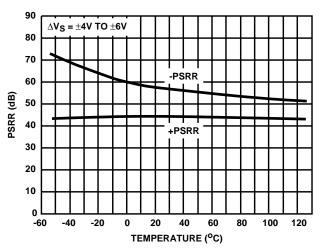


FIGURE 18. PSRR vs TEMPERATURE

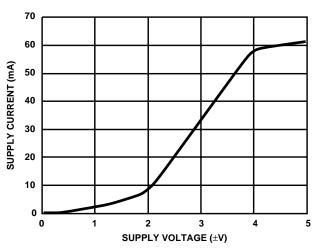


FIGURE 19. SUPPLY CURRENT vs SUPPLY VOLTAGE

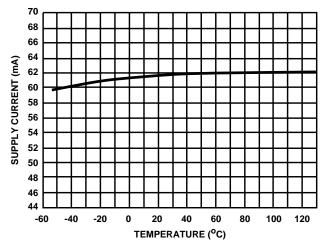


FIGURE 20. SUPPLY CURRENT vs TEMPERATURE

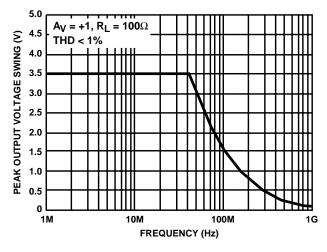
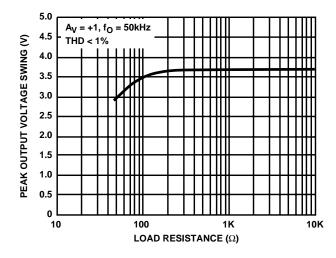


FIGURE 21. MAXIMUM OUTPUT VOLTAGE SWING vs FREQUENCY

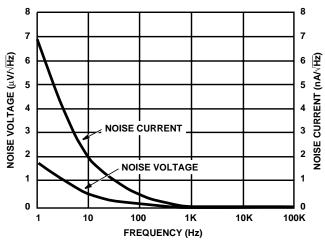
# Typical Performance Curves $V_S = \pm 5V$ , $T_A = +25$ °C, Unless Otherwise Specified (Continued)



240 V<sub>OUT</sub> = ±2V 220 200 OPEN LOOP GAIN (V/V) 180 160 140 120 100 80 60 40 10 100 1K 10K LOAD RESISTANCE ( $\Omega$ )

FIGURE 22. OUTPUT VOLTAGE SWING vs LOAD RESISTANCE

FIGURE 23. OPEN LOOP GAIN vs LOAD RESISTANCE



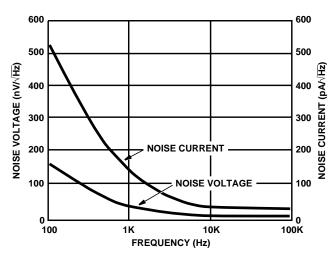
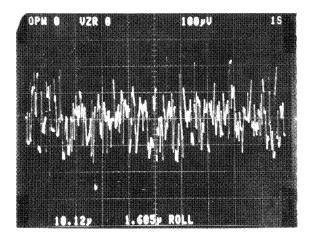


FIGURE 24. INPUT NOISE vs FREQUENCY

FIGURE 25. INPUT NOISE vs FREQUENCY



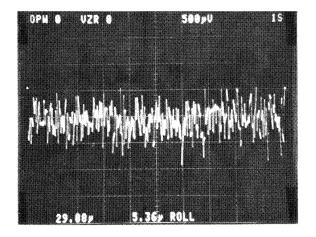


FIGURE 26. INPUT VOLTAGE NOISE 0.1Hz to 10Hz  $A_V = 50, \ Noise \ Voltage = 1.605 \mu Vrms \ (RTI) \\ Noise \ Voltage = 10.12 \mu V_{P-P}$ 

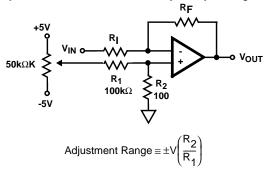
FIGURE 27. INPUT NOISE VOLTAGE 10Hz to 1MHz  $A_V = 50$ , Noise Voltage =  $5.36\mu Vrms$  (RTI) Noise Voltage =  $29.88\mu V_{P-P}$ 

## Applications Information

### Offset Adjustment

When applications require the offset voltage to be as low as possible, the figure below shows two possible schemes for adjusting offset voltage.

For a voltage follower application, use the circuit in Figure 29 without  $R_2$  and with  $R_1$  shorted.  $R_1$  should be  $1M\Omega$  to  $10M\Omega$ . The adjustment resistors will cause only a very small gain error.



**FIGURE 28. INVERTING GAIN** 

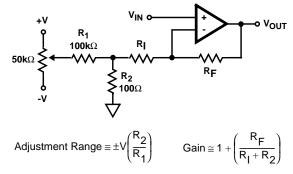


FIGURE 29. NON-INVERTING GAIN

#### PC Board Layout Guidelines

When designing with the HFA-0001, good high frequency (RF) techniques should be used when making a PC board. A massive ground plane should be used to maintain a low impedance ground. Proper shielding and use of short interconnection leads are also very important.

To achieve maximum high frequency performance, the use of low impedance transmission lines with impedance matching is recommended:  $50\Omega$  lines are common in communications and  $75\Omega$  lines in video systems. Impedance matching is important to minimize reflected energy therefore minimizing transmitted signal distortion. This is accomplished by using a series matching resistor ( $50\Omega$  or  $75\Omega$ ), matched transmission line ( $50\Omega$  or  $75\Omega$ ), and a matched terminating resistor, as shown in Figure 30. Note that there will be a 6dB loss from input to output.The HFA-0001 has an integral  $50\Omega \pm 20\%$  resistor connected to the op amps output with the other end of the resistor pinned out.

This  $50\Omega$  resistor can be used as the series resistor instead of an external resistor.

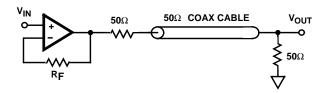


FIGURE 30.

PC board traces can be made to look like a  $50\Omega$  or  $75\Omega$  transmission line, called microstrip. Microstrip is a PC board trace with a ground plane directly beneath, on the opposite side of the board, as shown in Figure 31.

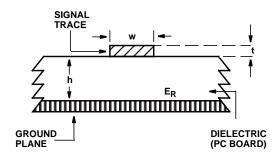


FIGURE 31.

When manufacturing pc boards, the trace width can be calculated based on a number of variables. The following equation is reasonably accurate for calculating the proper trace width for a  $50\Omega$  transmission line.

$$Z_{O} = \frac{87}{\sqrt{E_{R} + 1.41}} \ln \left( \frac{5.98h}{0.8w + t} \right) \Omega$$

Power supply decoupling is essential for high frequency op amps. A  $0.01\mu F$  high quality ceramic capacitor at each supply pin in parallel with a  $1\mu F$  tantalum capacitor will provide excellent decoupling as shown in Figure 32.

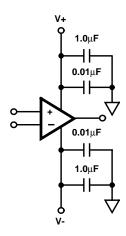
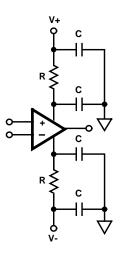


FIGURE 32. POWER SUPPLY DECOUPLING



#### FIGURE 33. IMPROVED DECOUPLING/CURRENT LIMITING

Chip capacitors produce the best results due to ease of placement next to the op amp and they have negligible lead inductance. If leaded capacitors are used, the leads should be kept as short as possible to minimize lead inductance. Figures 32 and 33 illustrate two different decoupling schemes. Figure 33 improves the PSRR because the resistor and capacitors create low pass filters. Note that the supply current will create a voltage drop across the resistor.

#### Saturation Recovery

When an op amp is over driven output devices can saturate and sometimes take a long time to recover. By clamping the input to safe levels, output saturation can be avoided. If output saturation cannot be avoided, the recovery time from 25% over-drive is 20ns and 30ns from 50% over-drive.

#### Thermal Management

The HFA-0001 can sink and source a large amount of current making it very useful in many applications. Care must be taken not to exceed the power handling capability of the part to insure proper performance and maintain high reliability. The following graph shows the maximum power handling capability of the HFA-0001 without exceeding the maximum allowable junction temperature of +175°C. The curves also show the improved power handling capability when heatsinks are used based on AVVID heatsink #5801B for the 8 lead Plastic DIP and IERC heatsink #PEP50AB for the 14 lead Sidebraze DIP. These curves are based on natural convection. Forced air will greatly improve the power dissipation capabilities of a heatsink.

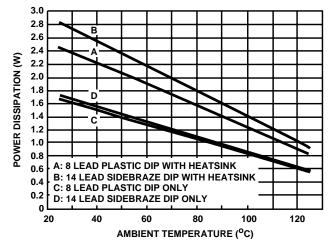


FIGURE 34.